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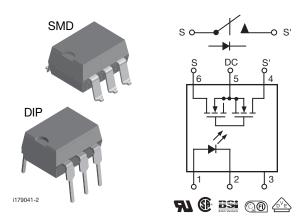




LH1546AT, LH1546AAB, LH1546AABTR

Vishay Semiconductors

1 Form A Solid-State Relay



DESCRIPTION

The LH1546 is robust, ideal for telecom and ground fault applications. It is a SPST normally open switch (1 form A) that replaces electromechanical relays in many applications. It is constructed using a GaAlAs LED for actuation control and an integrated monolithic die for the switch output. The die, fabricated in a high-voltage dielectrically isolated technology, is comprised of a photodiode array, switch control circuitry and MOSFET switches. In addition, it employs current-limiting circuitry which meets lightning surge testing as per ANSI/TIA-968-B and other regulatory voltage surge requirements when overvoltage protection is provided.

FEATURES

- · Current limit protection
- Isolation test voltage 5300 V_{RMS}
- Typical R_{ON} 28 Ω
- Load voltage 350 V
- Load current 120 mA
- · High surge capability
- Clean bounce free switching
- Low power consumption
- SMD lead available on tape and reel
- Equivalent to CP Clare LCA110
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

APPLICATIONS

- · General telecom switching
- Instrumentation
- Industrial controls

Note

• See "solid-state relays" (application note 56)

AGENCY APPROVALS

UL1577: file no. E52744 system code H, double protection

CSA: certification no. 093751

DIN EN: 60747-5-2 (VDE 0884)/60747-5-5 (pending),

available with option 1

BSI: certification no. 7979/7980

FIMKO: 25419

ORDERING INFORMATION	
L H 1 5 4 6 # PART NUMBER ELECT VARIATI	7.00
PACKAGE	UL, CSA, BSI, FIMKO
SMD-6, tubes	LH1546AAB
SMD-6, tape and reel	LH1546AABTR
DIP-6, tubes	LH1546AT

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ABSOLUTE MAXIMUM RATINGS	(T _{amb} = 25 °C, unless other	wise specified)		
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
INPUT				
LED continuous forward current		I _F	50	mA
LED reverse voltage	I _R ≤ 10 μA	V _R	8	V
OUTPUT				
DC or peak AC load voltage	I _L ≤ 50 μA	V_{L}	350	V
Continuous DC load current at 25 °C, bidirectional		Ι <u>ι</u>	120	mA
Continuous DC load current at 25 °C, unidirectional		ΙL	200	mA
SSR				
Ambient temperature range		T _{amb}	- 40 to + 85	°C
Storage temperature range		T _{stg}	- 40 to + 150	°C
Soldering temperature (1)	t = 10 s max.	T _{sld}	260	°C
Isolation test voltage	for 1 s	V _{ISO}	5300	V_{RMS}
lociotion vociotano	V _{IO} = 500 V, T _{amb} = 25 °C	R _{IO}	≥ 10 ¹²	Ω
Isolation resistance	V _{IO} = 500 V, T _{amb} = 100 °C	R _{IO}	≥ 10 ¹¹	Ω
SSR output power dissipation (continuous)		P _{diss}	550	mW

Notes

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not
 implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute
 maximum ratings for extended periods of the time can adversely affect reliability.
- (1) Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP).

ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT						
LED forward current, switch turn-on	$I_L = 100 \text{ mA}, t = 10 \text{ ms}$	I _{Fon}		1.1	2	mA
LED forward current, switch turn-off	$V_{L} = \pm 350 \text{ V}$	I _{Foff}	0.2	1		mA
LED forward voltage	I _F = 10 mA	V _F	1.15	1.26	1.45	V
OUTPUT						
On-resistance, AC/DC: pin 4 (±) to 6 (±)	I _F = 5 mA, I _L = 50 mA	R _{ON}		28	35	Ω
On-resistance, DC: pin 4, 6 (+) to 5 (-)	$I_F = 5 \text{ mA}, I_L = 50 \text{ mA}$	R _{ON}		7	10	Ω
Off-resistance	$I_F = 0 \text{ mA}, V_L = \pm 100 \text{ V}$	R _{OFF}	0.5	300		GΩ
Current limit AC (1): pin 4 (±) to 6 (±)	$I_F = 5 \text{ mA}, t = 5 \text{ ms}, V_L = 6 \text{ V}$	I _{LMT}	170	210	250	mA
Off state leakage assument	$I_F = 0 \text{ mA}, V_L = \pm 100 \text{ V}$	I _O		0.35	200	nA
Off-state leakage current	$I_F = 0 \text{ mA}, V_L = \pm 350 \text{ V}$	I _O		0.096	1	μΑ
Output conscitones pin 4 to 6	$I_F = 0 \text{ mA}, V_L = 1 \text{ V}$	Co		18		pF
Output capacitance pin 4 to 6	$I_F = 0 \text{ mA}, V_L = 50 \text{ V}$	Co		6.7		рF
Switch offset	I _F = 5 mA	V _{OS}		0.3		μV
TRANSFER						
Capacitance (input to output)	V _{ISO} = 1 V	C _{IO}		0.67		рF

Notes

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering
 evaluations. Typical values are for information only and are not part of the testing requirements.
- (1) No DC mode current limit available.

SWITCHING CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Turn-on time	$I_F = 5 \text{ mA}, I_L = 50 \text{ mA}$	t _{on}		1.14	3	ms
Turn-off time	$I_F = 5 \text{ mA}, I_L = 50 \text{ mA}$	t _{off}		0.71	3	ms



SAFETY AND INSU	LATION RATIN	GS			
PARAMETER		TEST CONDITION	SYMBOL	VALUE	UNIT
Climatic classification		IEC 68 part 1		40/85/21	
Pollution degree		DIN VDE 0109		2	
Tracking resistance (comparative tracking index	x)	Insulation group IIIa	СТІ	175	
Highest allowable overvoltage Transient overvoltage		Transient overvoltage	V _{IOTM}	8000	V _{peak}
Max. working insulation vol	tage	Recurring peak voltage	V _{IORM}	890	V _{peak}
Insulation resistance at 25 °C			R _{IS}	≥ 10 ¹²	Ω
Insulation resistance at T _S Insulation resistance at 100 °C		V _{IO} = 500 V	R _{IS}	≥ 10 ⁹	Ω
			R _{IS}	≥ 10 ¹¹	Ω
Partial discharge test voltage	је	Methode a, V _{pd} = V _{IORM} x 1.875	V_{pd}	1669	V _{peak}
Safety limiting values - Case temperature	Case temperature		T _{SI}	175	°C
maximum values allowed	Input current		I _{SI}	300	mA
in the event of a failure	Output power		Pso	700	mW
Minimum external air gap (d	clearance)	Measured from input terminals to output terminals, shortest distance through air		≥ 7	mm
Minimum external tracking (creepage)		Measured from input terminals to output terminals, shortest distance path along body		≥ 7	mm

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

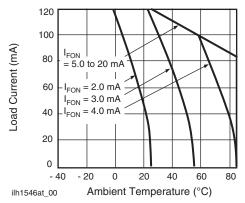


Fig. 1 - Recommended Operating Conditions

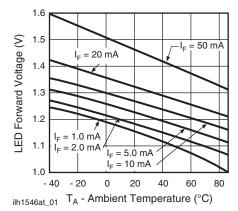


Fig. 2 - LED Voltage vs. Temperature

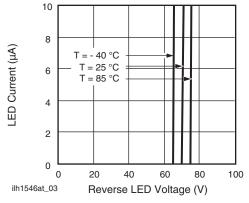


Fig. 3 - LED Reverse Current vs. LED Reverse Voltage

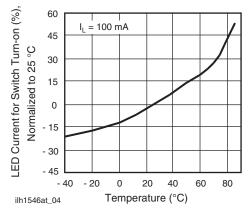


Fig. 4 - LED Current for Switch Turn-on vs. Temperature

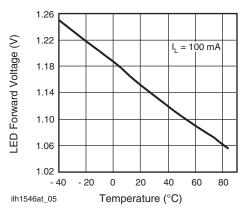


Fig. 5 - LED Dropout Voltage vs. Temperature

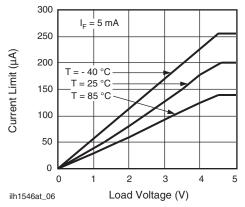


Fig. 6 - Load Current vs. Load Voltage

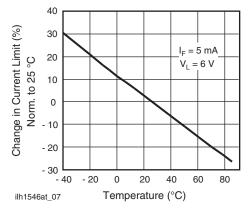


Fig. 7 - Current Limit vs. Temperature

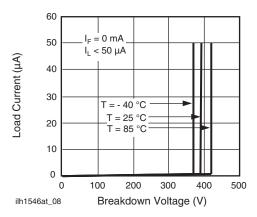


Fig. 8 - Switch Breakdown Voltage vs. Load Current

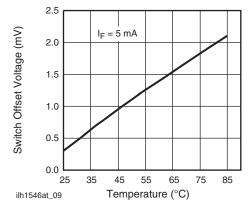


Fig. 9 - Switch Offset Voltage vs. LED Current

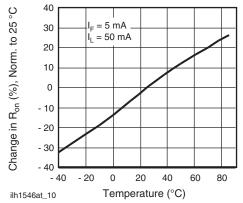


Fig. 10 - On-resistance vs. Temperature

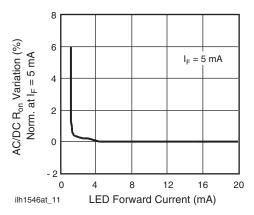


Fig. 11 - Variation in On-resistance vs. LED Current

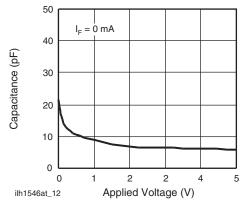


Fig. 12 - Switch Capacitance vs. Applied Voltage

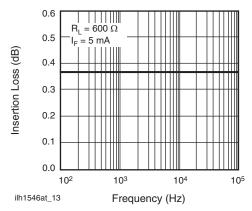


Fig. 13 - Insertion Loss vs. Frequency

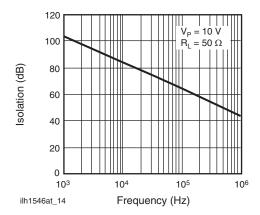


Fig. 14 - Output Isolation

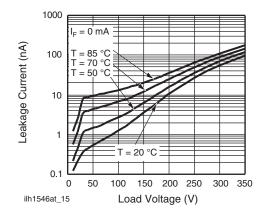


Fig. 15 - Leakage Current vs.
Applied Voltage at Elevated Temperatures

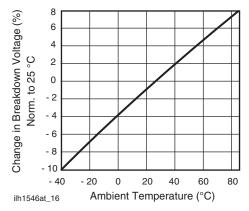


Fig. 16 - Switch Breakdown Voltage vs. Temperature

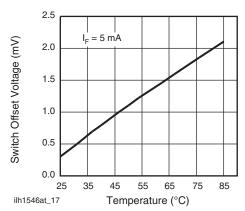


Fig. 17 - Switch Offset Voltage vs. Temperature

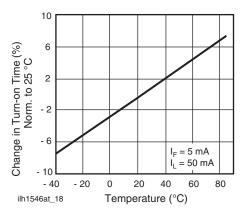


Fig. 18 - Turn-on Time vs. Temperature

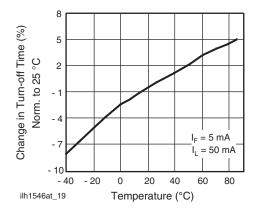


Fig. 19 - Turn-off Time vs. Temperature

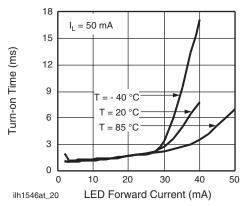


Fig. 20 - Turn-on Time vs. LED Current

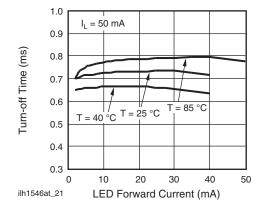
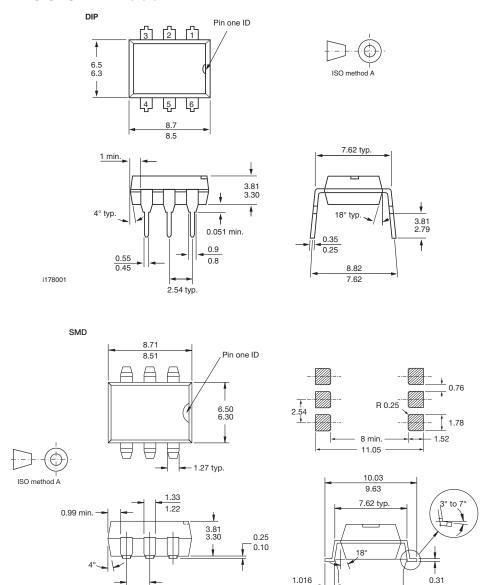


Fig. 21 - Turn-off Time vs. LED Current

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PACKAGE DIMENSIONS in millimeters



PACKAGE MARKING



0.508

8 min

Note

• Tape and reel suffix (TR) is no part of the package marking.

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Vishay

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